









Release Date: 03 October 2021 Version: A1.1

PRODUCT DATASHEET



- ► PLCC6 SMD
- ➤ 3433 1.92t Series
- ► Blue (465nm)

N0B49S38Z











3433 1.92t Series

FEATURES:



- Package: PLCC6 Top View White SMT Package
- Forward Current: 140mA Forward Voltage (typ.): 3.1V
- Luminous Intensity (typ.): 2600mcd@140mA
- Colour: Blue
- Wavelength (typ.): 465nm
- Viewing angle: 120°
- **Materials:**
 - Resin: Silicon (Water Clear)
 - L/T Finish: Ag plated
- **Operating Temperature:** -40~+105°C
- Storage Temperature: -40~+105°C
- ESD (HBM): 6kV
- **Grouping parameters:**
 - Forward voltage
 - Luminous intensity
 - **Dominant Wavelength**
- Soldering methods: IR Reflow
- MSL: acc. to JEDEC Level 2a (J-STD20D)
- Packing: 12mm tape with Max.1000/reel, ø180mm (7")

APPLICATIONS:

- Automotive
- **Decorative Lighting**
- Backlighting
- Indicator
- Dashboard
- Display



CHARACTERISTICS:

Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
Forward Current	I _F	240	mA
Pulse Forward Current Duty 1/10, width 0.1ms	IPF	300	mA
Reverse Voltage	V_R	5	V
Reverse Current @10V	I _R	10	μΑ
Junction Temperature	Tj	125	°C
Electrostatics Discharge (HBM)	ESD	6000	V
Operating Temperature	T_OPR	-40~+105	°C
Storage Temperature	T _{STG}	-40~+105	°C
Soldering Temperature	T _{SD}	260	°C
Thermal Resistance Junction/Soldering Point	RTH _{J-S}	80	°C/W

Electrical & Optical Characteristics (Ta=25°C)

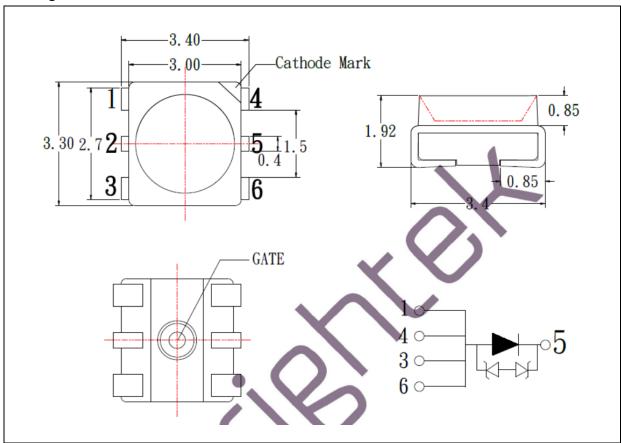
Darameter	Symbol	Values			Unit	Test
Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Forward Voltage	V_{F}	2.7	3.1	3.9	V	I _F =140mA
Luminous Intensity	lv	1700	2600		mcd	I _F =140mA
Luminous Flux	Ф۷		7.5		lm	I _F =140mA
Dominant Wavelength	λD	460		470	nm	I _F =140mA
Viewing Angle	2θ _{1/2}		120		deg	I _F =140mA

^{1.} Luminous intensity (Iv) $\pm 10\%$, Forward Voltage (V_F) $\pm 0.1V$, Viewing angle($2\theta_{1/2}$) $\pm 5\%$, Wavelength ± 1 nm



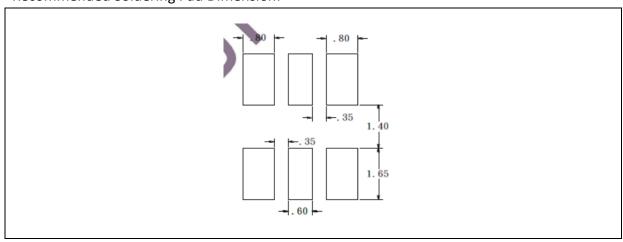
OUTLINE DIMENSION:

Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.2mm, unless otherwise noted.

Recommended Soldering Pad Dimension:



- 1. Dimensions are in millimetre (mm).
- 2. Tolerance ±0.1mm with angle tolerance ±0.5°.



BINNING GROUPS:

Forward Voltage Classifications (I_F = 140mA):

Code	Min.	Max.	Unit
Н	2.7	3.0	
I	3.0	3.3	V
J	3.3	3.6	V
К	3.6	3.9	

Luminous Intensity Classifications (I_F = 140mA):

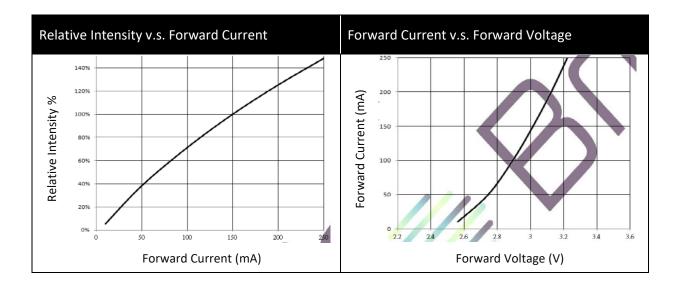
Code	Min.	Max.	Unit
17	1700	2200	
18	2200	2800	mcd
19	2800	3600	

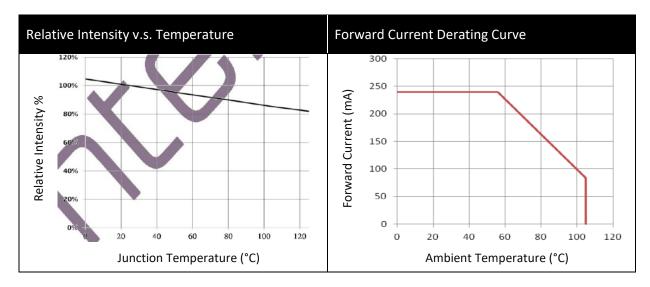
Dominant Wavelength Classifications (I_F = 140mA):

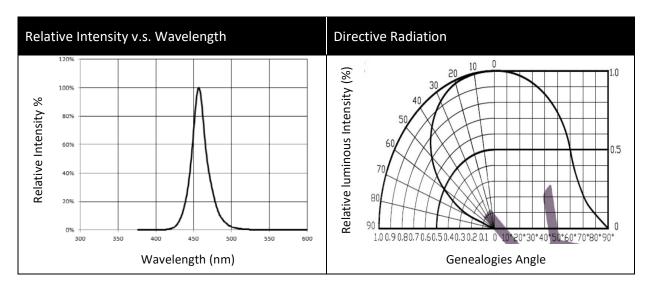
Code	Min.	Max.	Unit	
А	460	465		
В	465	470	nm	



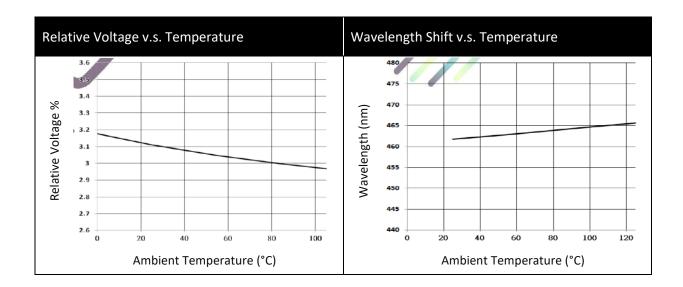
ELECTRO-OPTICAL CHARACTERISTICS:







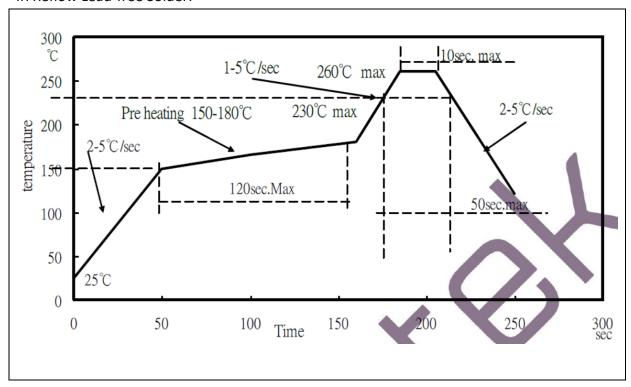






RECOMMENDED SOLDERING PROFILE:

IR Reflow Lead-free Solder:



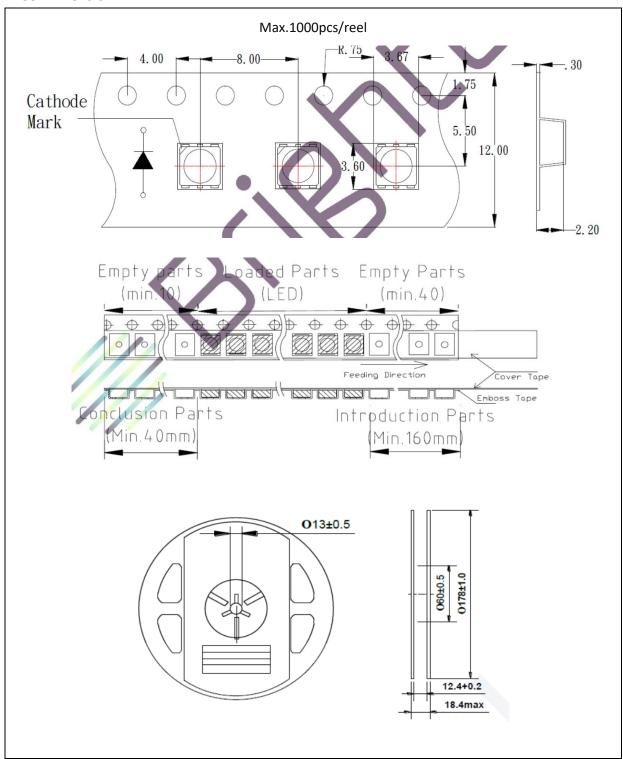
Note:

- 1. Maximum reflow soldering: 3 times.
- 2. Recommended reflow temperature 240°C. The maximum soldering temperature should be limited to 260°C.
- 3. Before, during, and after soldering, should not apply stress on the components and PCB board.



PACKING SPECIFICATION:

Reel Dimension:





PRECAUTIONS OF USE:

Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent <10% R.H. and apply baking before use.

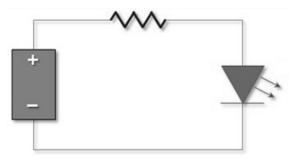
Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

• 60±3°C x 6hrs and <5%RH, for reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

Testing Circuit:



Must apply resistor(s) for protection (over current proof).

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



REVISION RECORD:

Version	Date	Summary of Revision
A1.0	28/05/2019	Datasheet set-up.
A1.1	03/10/2021	New datasheet format.